Errata **MSP430F2419 Microcontroller**

Texas Instruments

ABSTRACT

This document describes the known exceptions to the functional specifications (advisories).

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1 Functional Advisories

Advisories that affect the device's operation, function, or parametrics.

 \checkmark The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev H	Rev F	Rev E
ADC25	1	1	1
BCL12	1	1	1
BCL13			1
BCL15	1	1	1
FLASH19	1	1	1
FLASH24	1	1	1
FLASH25			1
FLASH27	\checkmark	1	1
FLASH36	1	1	1
PORT10	1	1	1
PORT12	1	1	1
TA12	1	1	1
TA16	1	1	1
TA21	1	1	1
TAB22	1	1	1
TB2	1	1	1
TB16	1	1	1
TB24	1	1	1
USCI20	1	1	1
USCI21	1	1	1
USCI22	1	1	1
USCI23	1	1	1
USCI24	1	1	1
USCI25	1	1	1
USCI26	1	1	1
USCI27	J J <td< td=""><td>1</td><td>1</td></td<>	1	1
USCI30	1	1	1
USCI34	1	1	1
USCI35	1	1	1
USCI40	1	1	1
XOSC5	1	J J <t< td=""><td>> > > <t< td=""></t<></td></t<>	> > <t< td=""></t<>
XOSC8		1	1

2 Preprogrammed Software Advisories

Advisories that affect factory-programmed software.

 \checkmark The check mark indicates that the issue is present in the specified revision.

The device does not have any errata for this category.

3 Debug Only Advisories

Advisories that affect only debug operation.

 \checkmark The check mark indicates that the issue is present in the specified revision.



Errata Number	Rev H	Rev F	Rev E
JTAG23	1	1	1

4 Fixed by Compiler Advisories

Advisories that are resolved by compiler workaround. Refer to each advisory for the IDE and compiler versions with a workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev H	Rev F	Rev E
CPU8	1	1	✓
CPU16	1	1	✓
CPU19	1	1	1

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

TI MSP430 Compiler Tools (Code Composer Studio IDE)

- MSP430 Optimizing C/C++ Compiler: Check the --silicon_errata option
- MSP430 Assembly Language Tools

MSP430 GNU Compiler (MSP430-GCC)

- MSP430 GCC Options: Check -msilicon-errata= and -msilicon-errata-warn= options
- MSP430 GCC User's Guide

IAR Embedded Workbench

• IAR workarounds for msp430 hardware issues



5 Nomenclature, Package Symbolization, and Revision Identification

The revision of the device can be identified by the revision letter on the Package Markings or by the HW ID located inside the TLV structure of the device.

5.1 Device Nomenclature

To designate the stages in the product development cycle. TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

XMS – Experimental device that is not necessarily representative of the final device's electrical specifications

MSP – Fully gualified production device

Support tool naming prefixes:

X: Development-support product that has not yet completed Texas Instruments internal qualification testing.

null: Fully-gualified development-support product.

XMS devices and X development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

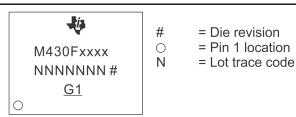
Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format.

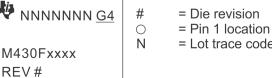
5.2 Package Markings

ZQW113

BGA (ZQW), 113 Pin



PM64 <i>LQFP (PM), 64 Pin</i>	
	W NNNNNN <u>G4</u>

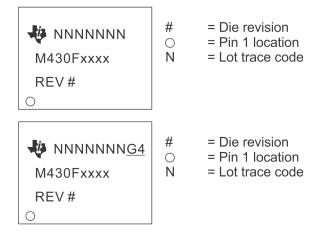


= Lot trace code

PN80

LQFP (PN), 80 Pin

REV # \bigcirc



ZCA113

NFBGA (ZCA), 113 Pin

MSP430™ xxxx NNNNNN# TI <u>G1</u>	xxxx N #	= Part number = Lot trace code = Die revision = Pin 1 location
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5.3 Memory-Mapped Hardware Revision (TLV Structure)

This device does not support reading the hardware revision from memory.

Further guidance on how to locate the TLV structure and read out the HW_ID can be found in the device User's Guide.

6 Advisory Descriptions



-					
ADC25	ADC Module				
Category	Functional				
Function	Write to ADC12CTL0 triggers ADC12 when CONSEQ = 00				
Description	If ADC conversions are triggered by the Timer_B module and the ADC12 is in single- channel single-conversion mode (CONSEQ = 00), ADC sampling is enabled by write access to any bit(s) in the ADC12CTL0 register. This is contrary to the expected behavior that only the ADC12 enable conversion bit (ADC12ENC) triggers a new ADC12 sample.				
Workaround	When operating the ADC12 in CONSEQ=00 and a Timer_B output is selected as the sample and hold source, temporarily clear the ADC12ENC bit before writing to other bits in the ADC12CTL0 register. The following capture trigger can then be re-enabled by setting ADC12ENC = 1.				
BCL12	BCL Module				
Category	Functional				
Function	Switching RSELx or modifying DCOCTL can cause DCO dead time or a complete DCO stop				
Description	After switching RSELx bits (located in register BCSCTL1) from a value of >13 to a value of <12 OR from a value of <12 to a value of >13, the resulting clock delivered by the DCO can stop before the new clock frequency is applied. This dead time is approximately 20 us. In some instances, the DCO may completely stop, requiring a power cycle.				
	Furthermore, if all of the RSELx bits in the BSCTL1 register are set, modifying the DCOCTL register to change the DCOx or the MODx bits could also result in DCO dead time or DCO hang up.				
Workaround	- When switching RSEL from >13 to <12, use an intermediate frequency step. The intermediate RSEL value should be 13.				
	Current RSEL Target RSEL Recommended Transition Sequence				

Current RSEL	Target RSEL	Recommended Transition Sequence
15	14	Switch directly to target RSEL
14 or 15	13	Switch directly to target RSEL
14 or 15	0 to 12	Switch to 13 first, and then to target RSEL (two step sequence)
0 to 13	0 to 12	Switch directly to target RSEL

AND

- When switching RSEL from <12 to >13 it's recommended to set RSEL to its default value first (RSEL = 7) before switching to the desired target frequency.

AND

- In case RSEL is at 15 (highest setting) it's recommended to set RSEL to its default value first (RSEL = 7) before accessing DCOCTL to modify the DCOx and MODx bits. After the DCOCTL register modification the RSEL bits can be manipulated in an additional step.

In the majority of cases switching directly to intermediate RSEL steps as described above will prevent the occurrence of BCL12. However, a more reliable method can be implemented by changing the RSEL bits step by step in order to guarantee safe function without any dead time of the DCO.

Note that the 3-step clock startup sequence consisting of clearing DCOCTL, loading the	9
BCSCTL1 target value, and finally loading the DCOCTL target value as suggested in th	е
in the "TLV Structure" chapter of the MSP430x2xx Family User's Guide is not affected	
by BCL12 if (and only if) it is executed after a device reset (PUC) prior to any other	
modifications being made to BCSCTL1 since in this case RSEL still is at its default	
value of 7. However any further changes to the DCOx and MODx bits will require the	
consideration of the workaround outlined above.	

BCL13	BCL Module				
Category	Functional				
Function	DCO powerup halt				
Description	When subject to very slow Vcc rise times, the device may enter into a state where the DCO does not oscillate. No JTAG access or program execution is possible and the device will remain in a reset state until the supply voltage is disconnected.				
Workaround	Apply a Vcc poweron ramp >-	Apply a Vcc poweron ramp >= 10V/second under all power-on/power-cycle scenarios.			
BCL15	BCL Module				
Category	Functional				
Function	Unpredictable device behavio LPM3	r if XT2 is sourcing SMCLK or	MCLK while operating in		
Description	If the MCLK or SMCLK is sourced by the XT2 oscillator, when the device wakes up from LPM3 or the SMCLK is requested by the USCI module an unpredictable glitch might appear. The glitch might appear on the corresponding clock signal with the 1st rising edge of the ACLK after wake-up. This can lead to a frequency violation. In case of MCLK it can cause the device to hang up or execute code incorrectly. In case of SMCLK any corresponding module using the clock can behave unpredictably.				
Workaround	Do not use XT2 clock for MCLK/SMCLK when using LPM3				
CPU8	CPU Module				
Category	Compiler-Fixed				
Function	Using odd values in the SP register				
Description	If the stack pointer (SP) is written with an odd value then the first time that the SP is used, the LSB of the SP is forced to zero.				
Workaround	Do not use odd values with th	e SP.			
	Refer to the table below for co	ompiler-specific fix implementa	tion information.		
	IDE/Compiler	Version Number	Notes		
	IAR Embedded Workbench	Not affected			
	TI MSP430 Compiler Tools (Code	Not affected			

Composer Studio)



IDE/Compiler	Version Number	Notes
MSP430 GNU Compiler (MSP430- GCC)	MSP430-GCC 4.9 build 389 or later	User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon- errata-warn=cpu8 generates a warning in addition
MSP430 GNU Compiler (MSP430- GCC)	MSP430-GCC 5.x build 14 or later	User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon- errata-warn=cpu8 generates a warning in addition

CPU16	CPU Module			
Category	Compiler-Fixed			
Function	Indexed addressing with instructions calla, mova and bra.			
Description	With indexed addressing mode and instructions calla, mova, and bra, it is not possible to reach memory above 64k if the register content is < 64k.			
	Example: Assume R5 = FFFEh. The instruction calla 0004h(R5) will result in a 20-bit call of address 0002h instead of 10002h.			
Workaround	- Use different addressing mode to reach memory above 64k. - First use adda [index],[Rx] to calculate address in upper memory and then do a calla [Rx]			
	Refer to the table below for co	ompiler-specific fix implementa	tion information.	
	IDE/Compiler	Version Number	Notes	
	IAR Embedded Workbench	IAR EW430 v6.30.1 or later		
	TI MSP430 Compiler Tools (Code Composer Studio)	Fix not available		
	MSP430 GNU Compiler (MSP430- GCC)	Fix not available		
CPU19	CPU Module			
Category	Compiler-Fixed			
Function	CPUOFF modification may result in unintentional register read			
Description	If an instruction that modifies the CPUOFF bit in the Status Register is followed by an instruction with an indirect addressed operand (e.g. MOV @R8, R9, RET, POP, POPM), an unintentional register read operation can occur during the wakeup of the CPU. If the unintentional read occurs to a read sensitive register (e.g. UCB0RXBUF, TAIV), which changes its value or the value of other registers (IFG's), the bug leads to lost interrupts or wrong register read values.			
Workaround	Insert a NOP instruction after	each CPUOFF instruction.		
	OR			



Refer to the table below for compiler-specific fix implementation information. Note that compilers implementing the fix may lead to double stack usage when RET/ RETA follows the compiler-inserted NOP.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v6.20.1 until v6.40	User is required to add the compiler or assembler flag option below hw_workaround=nop_after_lpm
IAR Embedded Workbench	IAR EW430 v6.40 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	15.12.0.LTS	User is required to add the compiler or assembler flag option below silicon_errata=CPU19
MSP430 GNU Compiler (MSP430- GCC)	MSP430-GCC 4.9 build 389 or later	User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon- errata-warn=cpu19 generates a warning in addition
MSP430 GNU Compiler (MSP430- GCC)	MSP430-GCC 5.x build 14 or later	User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon- errata-warn=cpu19 generates a warning in addition

FLASH19	FLASH Module
Category	Functional
Function	EEI feature does not work for code execution from RAM
Description	When the program is executed from RAM, the flash controller EEI feature does not work. The erase cycle is suspended and the interrupt is serviced, but there is a problem while resuming with the erase cycle.
	Addresses applied to flash are different than the actual values while resuming erase cycle after ISR execution.
Workaround	None
FLASH24	FLASH Module
Category	Functional
Function	Write or erase emergency exit can cause failures
Description	 When a flash write or erase is abruptly terminated, the following flash accesses by the CPU may be unreliable resulting in erroneous code execution. The abrupt termination can be the result of one the following events: 1) The flash controller clock is configured to be sourced by an external crystal. An oscillator fault occurs thus stopping this clock abruptly. or 2) The Emergency Exit bit (EMEX in FCTL3) when set forces a write or an erase operation to be terminated before normal completion.



	3) The Enable Emergency Interrupt Exit bit (EEIEX in FCTL1) when set with GIE=1 can lead to an interrupt causing an emergency exit during a Flash operation.
Workaround	1) Use the internal DCO as the flash controller clock provided from MCLK or SMCLK.
	or 2) After setting EMEX = 1, wait for a sufficient amount of time before Flash is accessed again.
	or 3) No Workaround. Do not use EEIEX bit.
FLASH25	FLASH Module
Category	Functional
Function	Marginal Read Mode is not functional
Description	The control bits for marginal read mode contained in the FCTL4 register are automatically cleared by any flash access. This prevents the marginal read mode from being used.
Workaround	It is possible to read out memory contents in marginal read mode if the indexed addressing mode X(Ry) is used to access the flash memory. In this case, the FCTL4 control bits are not cleared, and the marginal read mode works as expected. It is recommended to write the code for reading the flash memory contents in assembler as this allows full control over the used addressing mode. Note that certain assemblers may optimize an indexed addressing source operation of 0(Ry) to an indirect register mode @Ry operation, which will not work. The following is an example of reading the word memory location 0x4000 in marginal read mode, preventing a possible assembler optimization:
	dec.w R15 ; Decrement pointer mov.w 1(R15),R12 ; Read memory contents at R15+1, store result in R12
FLASH27	FLASH Module
Category	Functional
Function	EEI feature can disrupt segment erase
Description	When a flash segment erase operation is active with EEI feature selected (EEI=1 in FLCTL1) and GIE=0, the following can occur:
	An interrupt event causes the flash erase to be stopped, and the flash controller expects an RETI to resume the erase. Because GIE=0, interrupts are not serviced and RETI will never happen.
Workaround	 Do not set bit EEI=1 when GIE = 0. or, Force an RETI instruction during the erase operation during the check for BUSY=1 (FCLTL3).
	Sample code:
	MOV R5, 0(R5) ; Dummy write, erase segment LOOP: BIT #BUSY, &FCTL3 ; test busy bit JMP SUB_RETI ; Force RETI instruction JNZ LOOP ; loop while BUSY=1



SUB	RETI: PUSH SR
RETI	

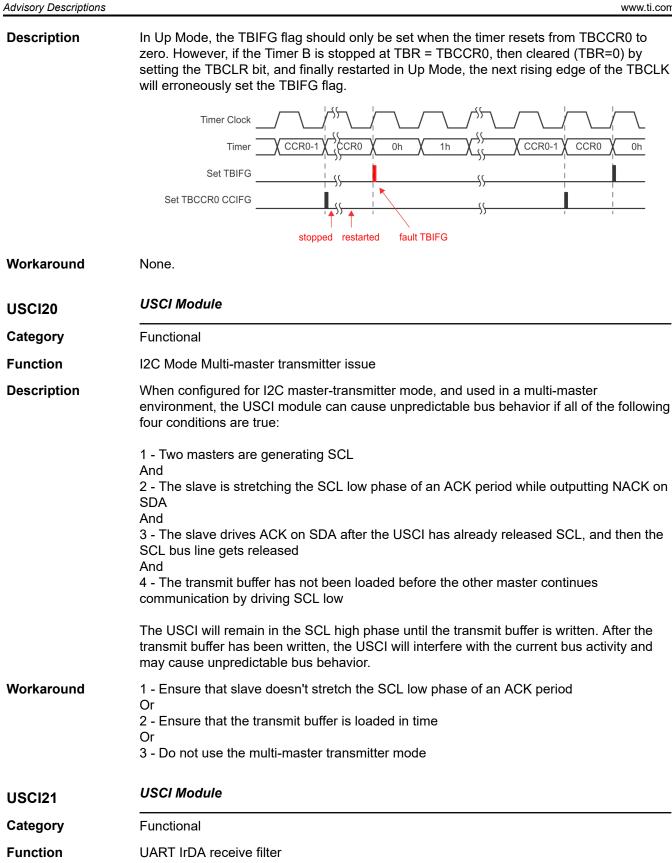
FLASH36	FLASH Module
Category	
Function	Flash content may degrade due to aborted page erases
Description	If a page erase is aborted by EEIEX, the flash page containing the last instruction before erase operation will start to degrade. This effect is incremental and, after repetitions, may lead to corrupted flash content.
Workaround	- Use the EEI (interrupted erasing) feature instead of EEIEX (abort erasing).
	or - A PSA checksum can be calculated over affected flash page using the marginal read mode (marginal 0). If PSA sum differs from expected PSA value the affected flash page has to be reprogrammed. or - Start flash erasing from RAM and limit system frequency to <1MHz (to ensure 6-us delay after EEIEX). If the last instruction before erasing is located in RAM, flash cell degradation does not occur.
JTAG23	JTAG Module
Category	Debug
Function	PSA checksum calculation does not work in marginal read mode.
Description	If the PSA checksum is calculated via JTAG interface in marginal read mode the MRG0 and MRG1 bits in the FCTL4 register are reset.
Workaround	None.
PORT10	PORT Module
Category	Functional
Function	Pull-up/down resistor selection when module pin function is selected
Description	When the pull-up/down resistor for a certain port pin is enabled (PxREN.y=1) and the module port pin function is selected (PxSEL.y=1), the pull-up/down resistor configuration of this pin is controlled by the respective module output signal (Module X OUT) instead of the port output register (PxOUT.y).
Workaround	None. Do not set PxSEL.y and PxREN.y at the same time.
PORT12	PORT Module
Category	Functional
Function	PxIFG is set on PUC
Description	The PxIN register is cleared when a PUC is asserted, and it regains the original value after the PUC is de-asserted. If the PxIN register bits read high, asserting a PUC causes clearing of the register, which results in a high-to-low transition. Once the PUC is de-asserted, the PxIN register is restored to high, which results in a low-to-high transition. This behavior results in the PxIFG being set regardless of the PxIES setting.



Advisory Descriptions	www.ti.com
Workaround	Prior to setting PxIE bits ensure that corresponding PxIFG bits are cleared.
TA12	TA Module
Category	Functional
Function	Interrupt is lost (slow ACLK)
Description	Timer_A counter is running with slow clock (external TACLK or ACLK)compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.
Workaround	Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.
TA16	TA Module
Category	Functional
Function	First increment of TAR erroneous when $IDx > 00$
Description	The first increment of TAR after any timer clear event (POR/TACLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.
Workaround	None
TA21	TA Module
Category	Functional
Function	TAIFG Flag is erroneously set after Timer A restarts in Up Mode
Description	In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.
	Timer Clock Timer CCR0-1 Set TAIFG Set TACCR0 CCIFG Stopped restarted
Workaround	None.
TAB22	TAB Module

Category	Functional
Function	Timer_A/Timer_B register modification after Watchdog Timer PUC
Description	Unwanted modification of the Timer_A/Timer_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer_A/Timer_B counter register TACCRx/TBCCRx is incremented/ decremented (Timer_A/Timer_B does not need to be running).
Workaround	Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.
	Example code:
	MOV.W #VAL, &TACTL or MOV.W #VAL, &TBCTL
	Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.
TB2	TB Module
Category	Functional
Function	Interrupt is lost (slow ACLK)
Description	Timer_B counter is running with slow clock (external TBCLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by 1 with the occurring compare interrupt (if TBR = CCRx). Due to the fast MCLK, the CCRx register increment (CCRx = CCRx + 1) happens before the Timer_B counter has incremented again. Therefore, the next compare interrupt should happen at once with the next Timer_B counter increment (if TBR = CCRx + 1). This interrupt is lost.
Workaround	Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterward.
TB16	TB Module
Category	Functional
Function	First increment of TBR erroneous when IDx > 00
Description	The first increment of TBR after any timer clear event (POR/TBCLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK, or TBCLK). This is independent of the clock input divider settings (ID0, ID1). All following TBR increments are performed correctly with the selected IDx settings.
Workaround	None
TB24	TB Module
Category	Functional
Function	TBIFG Flag is erroneously set after Timer B restarts in Up Mode





 Description
 The IrDA receive filter can be used to filter pulses with length UCAIRRXFL configured in UCAXIRRCTL register. If UCIRRXFE is set the IrDA receive decoder may filter out



pulses longer than the configured filter length depending on frequency of BRCLK. This is resulting in framing errors or corrupted data on the receiver side.

Workaround Depending on the used baud rate and the configured filter length a maximum frequency for BRCLK needs to be set to avoid this issue:

For baud rates equal and higher than 115.000 the maximum allowed BRCLK frequency is equal to the max specified system frequency.

Max BRCLK =
$$\frac{\text{Filter Length + 64}}{2} \times \frac{\text{Baud Rate } \times 16}{3 \times 10^6}$$

Baud Rate	Filter Length UCIRRXFL (dec)	Max BRCLK (MHz)
	64	3.28
	32	2.46
	16	2.05
9600	8	1.84
9000	4	1.74
	2	1.69
	1	1.66
	0	1.64
	64	6.55
	32	4.92
	16	4.1
19200	8	3.69
19200	4	3.48
	2	3.38
	1	3.33
	0	3.28
	64	13.11
	32	9.83
	16	8.19
00.400	8	7.37
38400	4	6.96
	2	6.76
	1	6.66
	0	6.55
	64	19.11
	32	14.34
	16	11.95
50000	8	10.75
56000	4	10.15
	2	9.86
	1	9.71
	0	9.56

USCI22

USCI Module

Category Functional

Function I2C Master Receiver with 10-bit slave addressing

Description Unexpected behavior of the USCI_B can occur when configured in I2C master receive mode with 10-bit slave addressing under the following conditions:

1) The USCI sends first byte of slave address, the slave sends an ACK and when second



	address byte is sent, the slave sends a NACK. 2) Master sends a repeat start condition (If UCTXSTT=1). 3) The first address byte following the repeated start is acknowledged.
	However, the second address byte is not sent, instead the Master incorrectly starts to receive data and sets UCBxRXIFG=1.
Workaround	Do not use repeated start condition instead set the stop condition UCTXSTP=1 in the NACK ISR prior to the following start condition (USTXSTT=1).
USCI23	USCI Module
Category	Functional
Function	UART transmit mode with automatic baud rate detection
Description	Erroneous behavior of the USCI_A can occur when configured in UART transmit mode with automatic baud rate detection. During transmission if a "Transmit break" is initiated (UCTXBRK=1), the USCI_A will not deliver a stop bit of logic high, instead, it will send a logic low during the subsequent synch period.
Workaround	 Follow User's Guide instructions for transmitting a break/synch field following UCSWRST=1. Or, Set UCTXBRK=1 before an active transmission, i.e. check for bit UCBUSY=0 and then set UCTXBRK=1.
USCI24	USCI Module
Category	Functional
Function	Incorrect baud rate information during UART automatic baud rate detection mode
Description	Erroneous behavior of the USCI_A can occur when configured in UART mode with automatic baud rate detection. After automatic baud rate measurement is complete, the UART updates UCAxBR0 and UCAxBR1. Under Oversampling mode (UCOS16=1), for baud rates that should result in UCAxBRx=0x0002, the UART incorrectly reports it as UCAxBRx=0x5555.
Workaround	When break/synch is detected following the automatic baud rate detection, the flag UCBRK flag is set to 1. Check if UCAxBRx=0x5555 and correct it to 0x0002.
USCI25	USCI Module
Category	Functional
Function	TXIFG is not reset when NACK is received in I2C mode
Description	When the USCI_B module is configured as an I2C master transmitter the TXIFG is not reset after a NACK is received if the master is configured to send a restart (UCTXSTT=1 & UCTXSTP=0).
Workaround	Reset TXIFG in software within the NACKIFG interrupt service routine
USCI26	USCI Module
Category	Functional

Function	Tbuf parameter violation in I2C multi-master mode
Description	In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C transaction, the USCI module waits and issues the start condition on bus release causing the violation to occur.
Workaround	Note: It is recommended to check if UCBBUSY bit is cleared before setting UCTXSTT=1.
workaround	None
USCI27	USCI Module
Category	Functional
Function	Timing of USCI I2C interrupts may cause device reset due to automatic clear of an IFG.
Description	When certain USCI I2C interrupt flags (IFG) are set and an automatic flag-clearing event on the I2C bus occurs, the program counter may become corrupted. This will only happen when the IFG is cleared within a critical time window (~6 CPU clock cycles) after a USCI interrupt request occurs and before the interrupt servicing is initiated. The affected interrupts are UCBxTXIFG, UCSTPIFG, UCSTTIFG and UCNACKIFG.
	The automatic flag-clearing scenarios are described in the following situations: (1) A pending UCBxTXIFG interrupt request is cleared on the falling SCL clock edge following a NACK. (2) A pending UCSTPIFG, UCSTTIFG, or UCNACKIFG interrupt request is cleared by a following Start condition.
Workaround	 (1) Polling the affected flags instead of enabling the interrupts. or (2) Ensuring the above mentioned flag-clearing events occur after a time delay of 6 CPU clock cycles has elapsed since the interrupt request occurred and was accepted.
USCI30	USCI Module
Category	Functional
Function	I2C mode master receiver / slave receiver
Description	When the USCI I2C module is configured as a receiver (master or slave), it performs a double-buffered receive operation. In a transaction of two bytes, once the first byte is moved from the receive shift register to the receive buffer the byte is acknowledged and the state machine allows the reception of the next byte.
	If the receive buffer has not been cleared of its contents by reading the UCBxRXBUF register while the 7th bit of the following data byte is being received, an error condition may occur on the I2C bus. Depending on the USCI configuration the following may occur:
	 If the USCI is configured as an I2C master receiver, an unintentional repeated start condition can be triggered or the master switches into an idle state (I2C communication aborted). The reception of the current data byte is not successful in this case. If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in this case. If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in this case. The USCI I2C state machine will notify the master of the aborted reception with a NACK.

Note that the error condition described above occurs only within a limited window of the



	7th bit of the current byte being received. If the receive buffer is read outside of this window (before or after), then the error condition will not occur.
Workaround	a) The error condition can be avoided altogether by servicing the UCBxRXIFG in a timely manner. This can be done by (a) servicing the interrupt and ensuring UCBxRXBUF is read promptly or (b) Using the DMA to automatically read bytes from receive buffer upon UCBxRXIFG being set.
	OR
	b) In case the receive buffer cannot be read out in time, test the I2C clock line before the UCBxRXBUF is read out to ensure that the critical window has elapsed. This is done by checking if the clock line low status indicator bit UCSCLLOW is set for atleast three USCI bit clock cycles i.e. 3 X t(BitClock).
	Note that the last byte of the transaction must be read directly from UCBxRXBUF. For all other bytes follow the workaround:
	Code flow for workaround
	 (1) Enter RX ISR for reading receiving bytes (2) Check if UCSCLLOW.UCBxSTAT == 1 (2) If no more states 2 with est
	 (3) If no, repeat step 2 until set (4) If yes, repeat step 2 for a time period > 3 x t (BitClock) where t (BitClock) = 1/ f (BitClock) (5) If window of 3 x t(BitClock) cycles has elapsed, it is safe to read UCBxRXBUF
USCI34	USCI Module
Category	Functional
Function	I2C multi-master transmit may lose first few bytes.
Description	In an I2C multi-master system (UCMM =1), under the following conditions:
	(1)the master is configured as a transmitter (UCTR =1)
	AND
	(2)the start bit is set (UCTXSTT =1);
	if the I2C bus is unavailable, then the USCI module enters an idle state where it waits and checks for bus release. While in the idle state it is possible that the USCI master updates its TXIFG based on clock line activity due to other master/slave communication on the bus. The data byte(s) loaded in TXBUF while in idle state are lost and transmit pointers initialized by the user in the transmit ISR are updated incorrectly.
Workaround	Verify that the START condition has been sent (UCTXSTT =0) before loading TXBUF with data.
	Example: #pragma vector = USCIAB0TX_VECTOR interrupt void USCIAB0TX_ISR(void)
	{ // Workaround for USCI34 if(UCB0CTL1&UCTXSTT) {

	<pre>// TXData = pointer to the transmit buffer start // PTxData = pointer to transmit in the ISR PTxData = TXData; // restore the transmit buffer pointer if the Start bit is set } // if(IFG2&UCB0TXIFG) { if (PTxData < = PTxDataEnd) // Check TX byte counter { UCB0TXBUF = *PTxDataEnd) // Check TX buffer } else { UCB0CTL1 = UCTXSTP; // I2C stop condition IFG2 &= ~UCB0TXIFG; // Clear USCI_B0 TX int flag bic_SR_register_on_exit(CPUOFF); // Exit LPM0 } }</pre>
USCI35	USCI Module
Category	Functional
Function	Violation of setup and hold times for (repeated) start in I2C master mode
Description	In I2C master mode, the setup and hold times for a (repeated) START, t _{SU,STA} and t _{HD,STA} respectively, can be violated if SCL clock frequency is greater than 50kHz in standard mode (100kbps). As a result, a slave can receive incorrect data or the I2C bus can be stalled due to clock stretching by the slave.
Workaround	If using repeated start, ensure SCL clock frequencies is < 50kHz in I2C standard mode (100 kbps).
USCI40	USCI Module
Category	Functional
Function	SPI Slave Transmit with clock phase select = 1
Description	In SPI slave mode with clock phase select set to 1 (UCAxCTLW0.UCCKPH=1), after the first TX byte, all following bytes are shifted by one bit with shift direction dependent on UCMSB. This is due to the internal shift register getting pre-loaded asynchronously when writing to the USCIA TXBUF register. TX data in the internal buffer is shifted by one bit after the RX data is received.
Workaround	Reinitialize TXBUF before using SPI and after each transmission. If transmit data needs to be repeated with the next transmission, then write back previously read value: UCAXTXBUF = UCAXTXBUF;
XOSC5	XOSC Module

Category

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Functional



Function	LF crystal failures may not be properly detected by the oscillator fault circuitry					
Description	The oscillator fault error detection of the LFXT1 oscillator in low frequency mode (XTS = 0) may not work reliably causing a failing crystal to go undetected by the CPU, i.e. OFIFG will not be set.					
Workaround	None					
XOSC8	XOSC Module					
Category	Functional					
Function	ACLK failure when crystal ESR is below 40 kOhm.					
Description	When ACLK is sourced by a low frequency crystal with an ESR below 40 kOhm, the duty cycle of ACLK may fall below the specification; the OFIFG may become set or in some instances, ACLK may stop completely.					
Workaround	Please refer to "XOSC8 Guidance" found at SLAA423 for information regarding working with this erratum.					



7 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes	from	February	20	2020 to	May	/ 19	2021
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С	hanges from February 20, 2020 to May 19, 2021	Page
•	Changed the document format and structure; updated the numbering format for tables, figures, and cro	ss
	references throughout the document	6

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